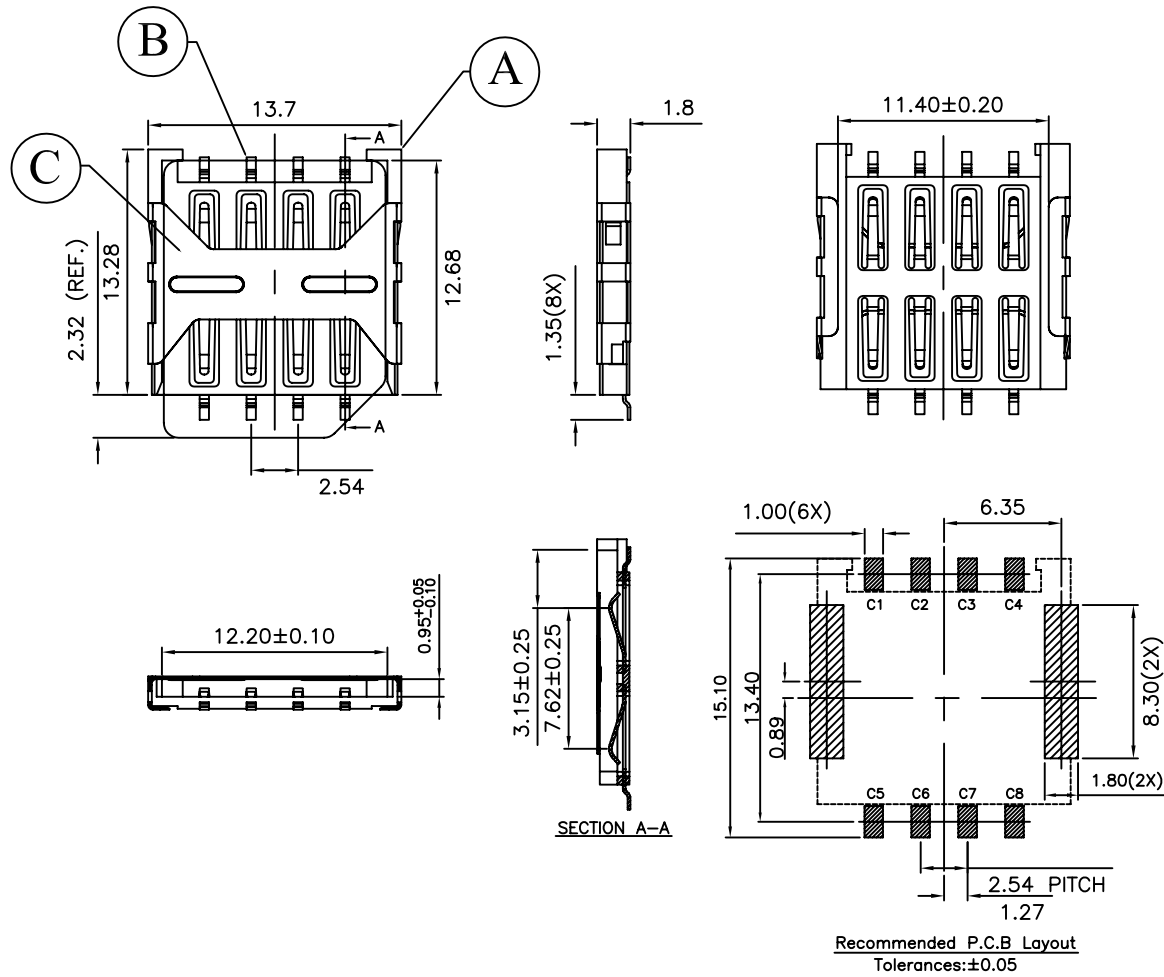
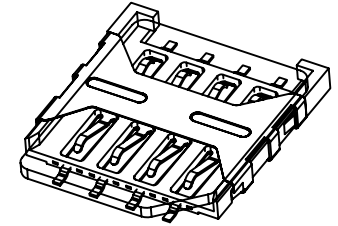


SWITCH CIRCUIT			MATERIAL AND FINISH AS BELOW						
WHEN CARD IS EJECTED	WHEN CARD IS INSERTED	A	Housing	LCP UL94V-0, Color:Black	E				
		B	Contact	Phosphor Bronze T=0.15, Contact Area: Gold Plated	F				
		C	Shell	Stainless Steel, Solder Tail:Gold Plated	G				
		D			H				



SPECIFICATION:

1. ELECTRICAL
 - 1.1 Current Rating: 0.5A
 - 1.2 Voltage Rating: 5VDC
 - 1.3 Contact Resistance: 100mΩ
 - 1.4 Insulation Resistance: 100MΩ
 - 1.5 Dielectric Withstanding Voltage: 100VAC for 1 minute
2. MECHANICAL
 - 2.1 Durability: 5000 Cycle
 - 2.2 Contact Normal Force : 0.2N~0.6N
3. ENVIRONMENTAL
 - 3.1 Operating temperature range: -40°C to +85°C
 - 3.2 Storage temperature range: -40°C to +85°C
4. SOLDER ABILITY
 - 4.1 Recommended IR Reflow Temperature: 260°C



Vcc	RST	CLK	NA	GND	Vpp	I/O	NA				
C1	C2	C3	C4	C5	C6	C7	C8				
PIN ASSIGNMENT											
115I-BEAA Micro SIM Socket 8Pin SMD Type,15u" Gold Plating											
PRODUCT NO.						DESCRIPTION					

UNLESS OTHERWISE SPECIFIED TOLERANCE		
ANGLES	ANG.	±5°
LINEAR	0.	±0.3
	0.0	±0.25
	0.00	±0.20
SCALE	AS SHOWN	UNIT: mm
DRAWN	Willis	2012/08/03
CHECKED	Angel	2012/08/03
APPROVED	Ken	2012/08/03



www.attend.com.tw

DRAWN NAME: Micro SIM Card Socket

PRODUCT NO. 115I-BEAA

Revise:											
Revise:											
Revise:											

REV.	DESCRIPTION	DATE	REV.	DESCRIPTION	DATE	SIZE	REV.	FILE NAME
1			4			A4	1.0	115I-BEAA_B_2

